

12-05-2005



Tab settings → → → ▼ ▼

To the Director of the United States Patent and Trademark Office

103130032

Attached original documents or copy thereof.

## 1. Name of conveying party(ies):

Young-il KIM, Jung-ho KANG, Tae-sik PARK

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

## 2. Name and address of receiving party(ies):

Name: SAMSUNG ELECTRONICS CO., LTD.

Address: 416, Maetan-dong, Yeongtong-gu

113260 U.S. PTO  
11/286030  
112305

## 3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

City: Suwon-si State/Prov.: Gyeonggi-do

Country: Korea

ZIP:

Execution Date: November 21, 2005

Additional name(s) &amp; address(es)

☐ Yes ☒ No

## 4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: November 21, 2005

Patent Application No.

Filing date

B. Patent No.(s)

12/02/2005 DBYRNE 00000128 061130 11286030

01 FC:8021

40.00 DA

Additional numbers

☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Jae Y. PARK

Registration No. Ltd. Recognition No. L0077

Address: Cantor Colburn LLP

55 Griffin Road South

City: Bloomfield

State/Prov.: CT

Country: USA

ZIP: 06002

## 6. Total number of applications and patents involved:

1

## 7. Total fee (37 CFR 3.41):.....\$ 40.00

☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☒ Authorized to be charged to deposit account

## 8. Deposit account number:

06-1130

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

## 9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Jae Y. PARK

Name of Person Signing

Signature

November 23, 2005

Date

3

Total number of pages including cover sheet, attachments, and document:

Mail documents to be recorded with required cover sheet information to:  
Mail Stop Assignment Recordation Services  
Director of the United States Patent and Trademark Office  
P.O. Box 1450, Alexandria, VA 22313-1450PATENT  
REEL: 017274 FRAME: 0186

11-23-05

## ASSIGNMENT

WHEREAS We, **Young-il KIM** of 109-403, **Cheoncheon Raemian, 544, Cheoncheon-dong, Jangan-gu, Suwon-si, Gyeonggi-do, Korea**, **Jung-ho KANG** of 1-408, **Samsung 3<sup>rd</sup> Apartment, 1217-7, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea**, and **Tae-sik PARK** of 331-203, **Byucksan Apartment, 3danji, Cheongmyeong Maeul, Yeongtong-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea** (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

### **BIOSENSOR, BIOSENSOR SYSTEM AND METHOD OF USING THEREOF**

which claims priority to Korean Application No. 2005-02406, filed on January 11, 2005, and for which We are about to file an application for Letters Patent of the United States;

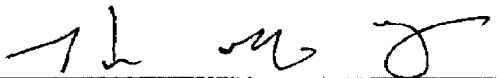
AND WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of the Republic of Korea, having a place of business at **416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications

when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

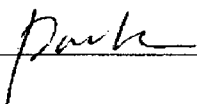
Date: NOV. 21, 2005

 L.S.  
**Young-il KIM**

Date: NOV. 21, 2005

 L.S.  
**Jung-ho KANG**

Date: NOV. 21, 2005

 L.S.  
**Tae-sik PARK**